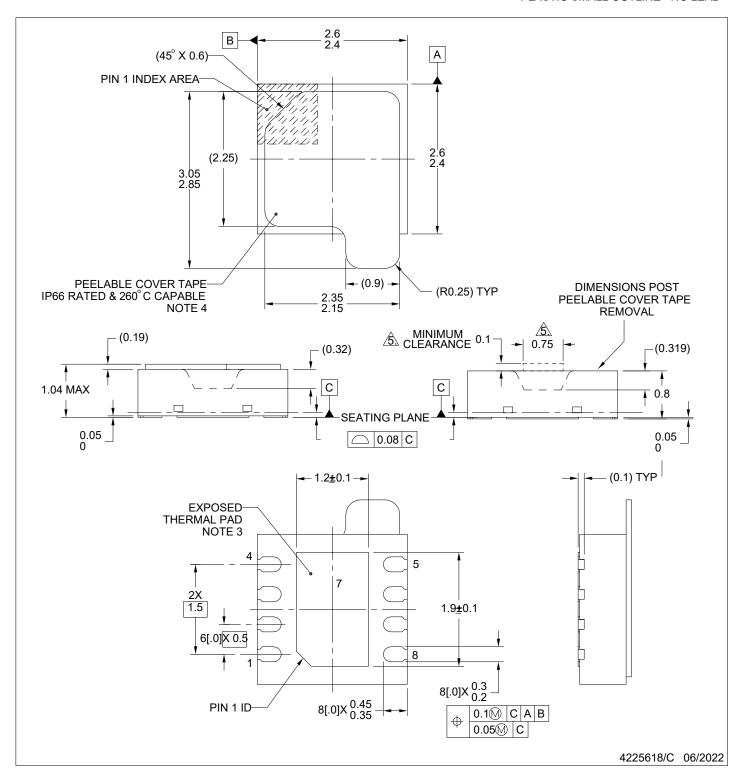
PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- It is generally best practice to solder the package thermal pad to a board pad that is connected to ground, however to minimize thermal mass for maximum heater efficiency or to measure ambient temperature it may be left floating.
- 4. IPXY Rating represents environmental ingress protection from both dust and high pressure water sprays. X=6 represents resistance to dust and Y=6 represents high pressure water spray resistance per IEC60529 testing conditions.
- Customers must maintain adequate clearance from this region to allow for proper functioning of the humidity sensor.

